503305807 05/13/2015

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
PATRICK O. TENNICAN	05/13/2015

RECEIVING PARTY DATA

Name:	HYPROTEK, INC.
Street Address:	4219 E. 65TH AVENUE
City:	SPOKANE
State/Country:	WASHINGTON
Postal Code:	99223-1806

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13571757

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ATTORNEY DOCKET NUMBER:	H014-0019US
NAME OF SUBMITTER:	JENNIFER PHIPPS
SIGNATURE:	/Jennifer Phipps/
DATE SIGNED:	05/13/2015

Total Attachments: 2 source=1BJ7904#page1.tif source=1BJ7904#page2.tif

PATENT 503305807 REEL: 035633 FRAME: 0286

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial Number	
Filing Date	8/10/2012
Inventorship	
Applicant	
Attorney's Docket No.	
Client Docket No.	Medical Caps and Methods of Use

PATENT ASSIGNMENT

PARTIES TO THE ASSIGNMENT

Assignor(s):

Patrick O. Tennican 4219 East 65th Avenue Spokane, WA 99223

Assignee:

Hyprotek, Inc. 4219 E. 65th Avenue Spokane, WA, 99223-1806

AGREEMENT

WHEREAS, ASSIGNOR(S) (listed above) are inventor(s) of an invention entitled "Medical Caps and Methods of Use" for which:

⊠ a non-provisional application for United States Letters Patent was:

filed on <u>8/10/2012</u> and was given U.S. Serial No. <u>13/571,757</u>; or filed concurrently herewith. Assignors hereby authorize and request ASSIGNEE's legal representatives, of Lee & Hayes, PLLC, 601 W Riverside Ave, Suite 1400, Spokane, Washington 99201, who are associated with customer number 29150, to insert in the caption above the serial number and filing date of the patent application when known.

WHEREAS, Hyprotek, Inc. (hereinafter referred to as ASSIGNEE), a corporation of the State of WA, having a place of business at 4219 E. 65th Avenue, Spokane, WA 99223-1806,

PATENT REEL: 035633 FRAME: 0287

Attorney Docket No. H014-0019US

desires to acquire the entire right, title and interest in and to the invention and in and to any

letters patent that may be granted in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of

which is hereby acknowledged, ASSIGNOR(S) hereby sell, assign and transfer unto ASSIGNEE,

the entire right, title and interest in and to said application and any and all letters patent which

may be granted for said invention in the United States of America and its territorial possessions

and in any and all foreign countries, and in any and all divisions, reissues and continuations

thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to

claim priority rights deriving from said United States application to which said foreign

applications are entitled by virtue of international convention, treaty or otherwise, said

invention, application and all letters patent on said invention to be held and enjoyed by

ASSIGNEE and its successors and assigns for their use and benefit and of their successors and

assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNOR(S)

had this assignment, transfer and sale not been made. ASSIGNOR(S) hereby authorize and

request the Commissioner of Patents and Trademarks to issue all letters patent on said

invention to ASSIGNEE. ASSIGNOR(S) agree to execute all instruments and documents

required for the making and prosecution of applications for United States and foreign letters

patent on said invention, for litigation regarding said letters patent, or for the purpose of

protecting title to said invention or letters patent.

May 13, 2015

Patrick O. Tennican